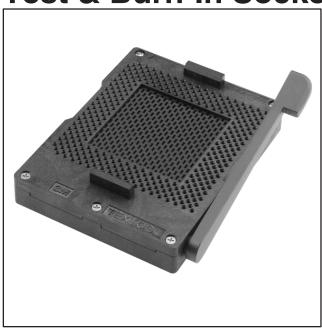
3M Textool, Interstitial Pin Grid Array Test & Burn-In Sockets



- 19 X 19 outer matrix with 18 X 18 inner staggered matrix holds up to 685 leads.
- · Lever actuated, zero insertion force mechanism.
- Rugged, 3-plate construction for durability and electrical reliability.
- Accommodates two lead diameter variations
 .25 .40 mm (.010" .016") inquire*
 .35 .51 mm (.014" .020") available
 *Note: Please contact 3M customer service for

availability.

Date Issued: June 20, 2001

TS-1358-04 Sheet 1 of 3

Physical

Insulation:

Material: Polyethersulfone (PES)

Flammability: UL 94V-0 Color: Black

Cam Handle:

Material: Aluminum Alloy, Die Cast

Contact:

Material: Beryllium Copper

Plating: $30 \mu'' (0.76 \mu m)$ Gold over $50 \mu'' (1.3 \mu m)$ Nickel

Other Metal Parts: Stainless Steel

Marking: 3M Logo / Textool Logo

Electrical

 $\begin{array}{c} \text{Insulation Resistance:} & > 500 \text{M}\Omega \text{ at } 500 \text{ Vdc} \\ \text{Dielectric Withstanding Voltage:} & 500 \text{ Vrms at Sea Level} \\ \text{Initial Contact Resistance:} & 25 \mu\Omega \text{ max. initially} \end{array}$

Current Rating: 1.0 A max.

Environmental

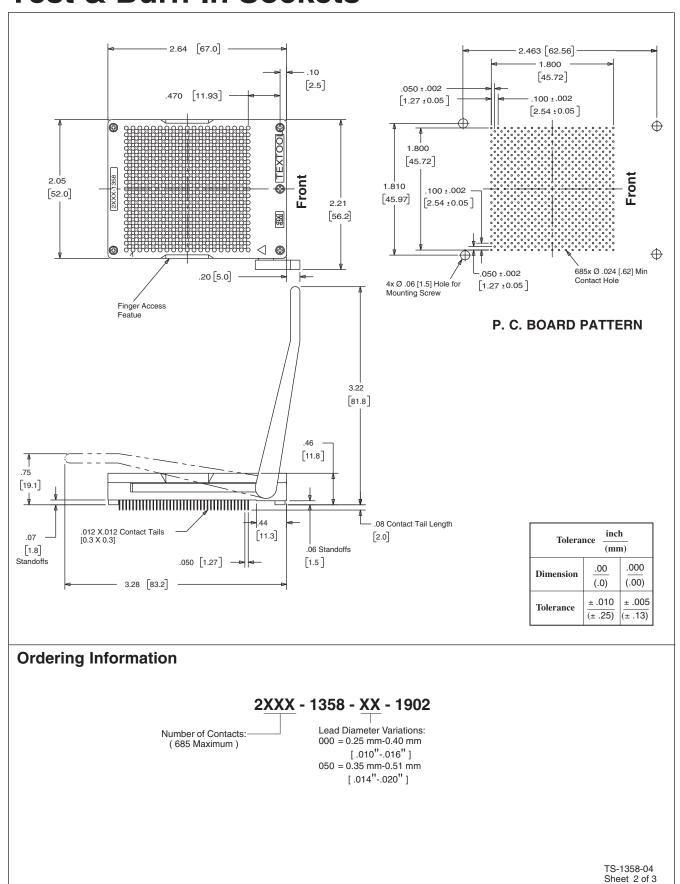
Operating Temperature Rating: -55° C to +150° C

Mechanical

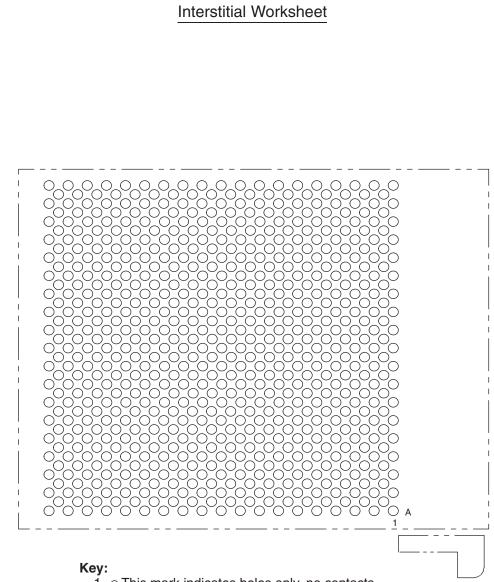
Durability: When used as a test socket at room temperature

the socket will last 3,000 actuations.

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- 1. O This mark indicates holes only, no contacts.
- 2. This mark indicates holes with contacts.

Notes:

- 1. This is only a work sheet. Do not proceed with any layout until a part number is assigned by 3M Textool. The pattern is subject to repositioning.
- 2. Lead diameter = .016 [0.39] min, .020 [0.51] max. The standard socket has been designed to accept these lead diameters only. For all others please consult the factory.
- 3. Use this sheet to indicate which positions you intend to use.
- 4. The device lead must be a minimum of 2.54 [.100] below the standoffs on the device leads.

TS-1358-04 Sheet 3 of 3